



TSMC 00-563

Application no. 09/863,224

August 25, 2003

TO: Commissioner of Patents
P.O. Box 1450
Alexandria VA 22313-1450

FROM: Stephen Ackerman Reg. No. 37,761
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SUBJECT: Serial # 09/863,224 File Date: 05/24/2001
Inventor: Ming-Hsing Tsai
Examiner: Neal Berezny
Art Unit: 2823
Title: A Method To Solve Via Poisoning For Porous Low-K Dielectric

PRELIMINARY AMENDMENT

This is in response to the Advisory Action dated 08/06/2003. Please amend the above identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:
Commissioner of Patents P.O. Box 1450 Alexandria VA 22313-1450 on
5, 2003.

Signature George O. Saile Date: Sept. 5, 2003
George O. Saile, Reg. No. 19,572